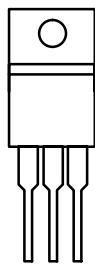


N-Channel 40-V (D-S) 175°C MOSFET

PRODUCT SUMMARY		
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
40	0.004 @ $V_{GS} = 10$ V	85 a

175°C Rated
Maximum Junction Temperature
TrenchFET®
Power MOSFETs

TO-220AB



DRAIN connected to TAB

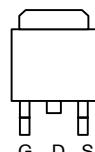
Top View

Ordering Information

SUP85N04-04

SUP85N04-04—E3 (Lead (Pb)-Free)

TO-263

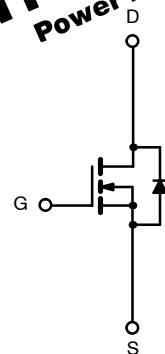


Top View

Ordering Information

SUB85N04-04

SUB85N04-04—E3 (Lead (Pb)-Free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	40	
Gate-Source Voltage	V_{GS}	20	V
Continuous Drain Current ($T_j = 175^\circ\text{C}$)	I_D	85 ^a	A
		85 ^a	
Pulsed Drain Current	I_{DM}	240	
Avalanche Current	I_{AR}	70	
Repetitive Avalanche Energy ^b	E_{AR}	211	mJ
Maximum Power Dissipation ^b	P_D	250 ^c	W
		3.75	
Operating Junction and Storage Temperature Range	T_j, T_{stg}	-55 to 175	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Limit	Unit
Junction-to-Ambient	R_{thJA}	40	°C/W
Free Air (TO-220AB)		62.5	
Junction-to-Case	R_{thJC}	0.6	

Notes

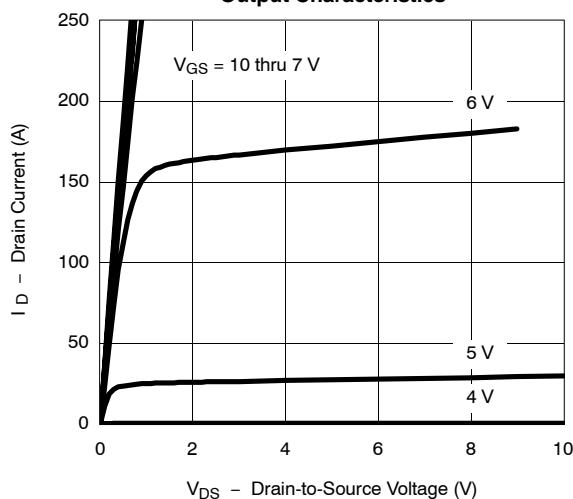
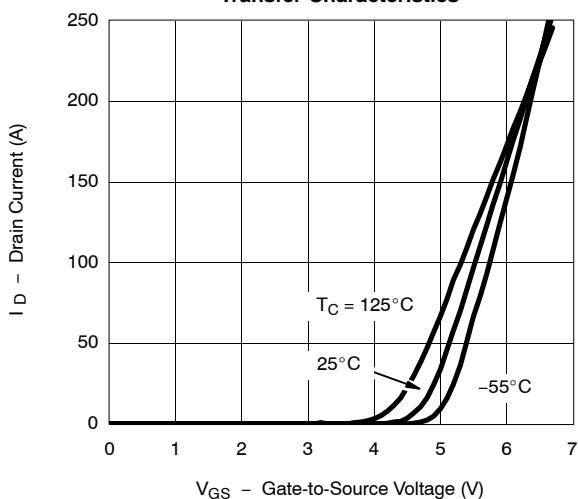
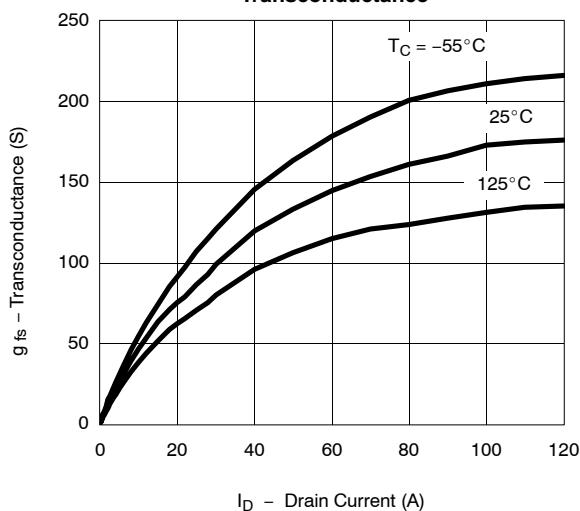
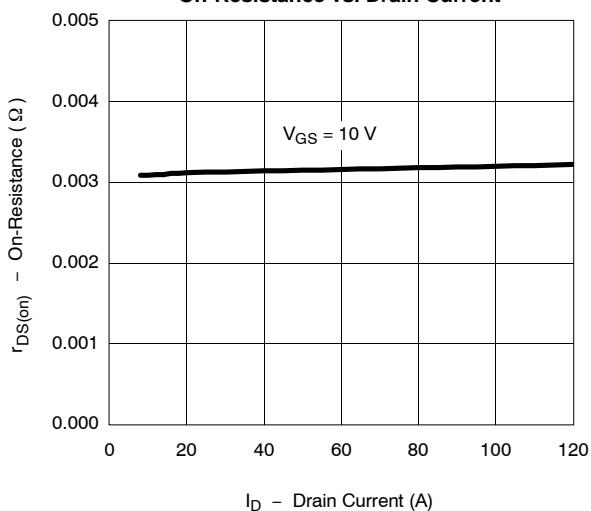
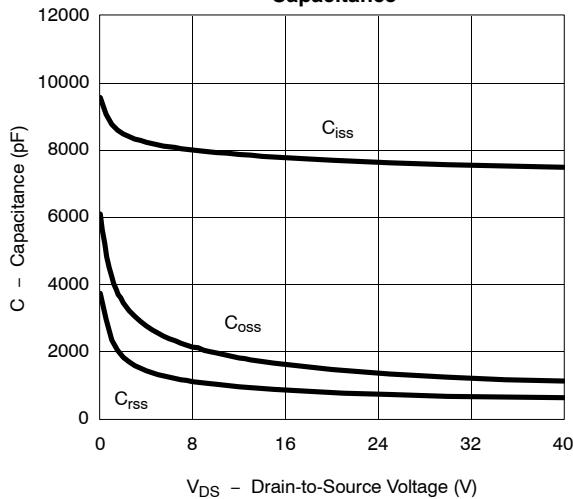
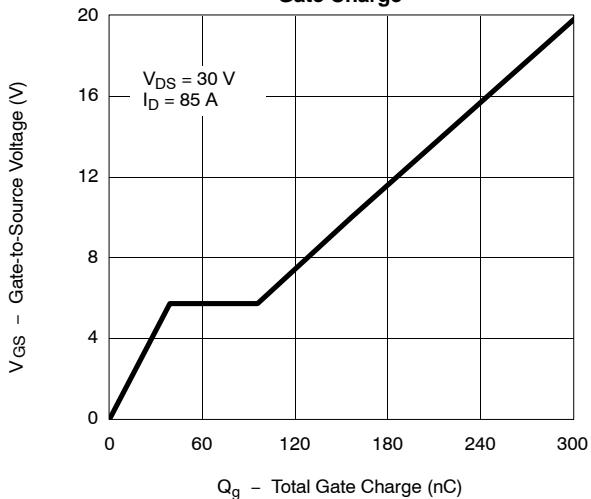
- a. Package limited.
- b. Duty cycle $\leq 1\%$.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

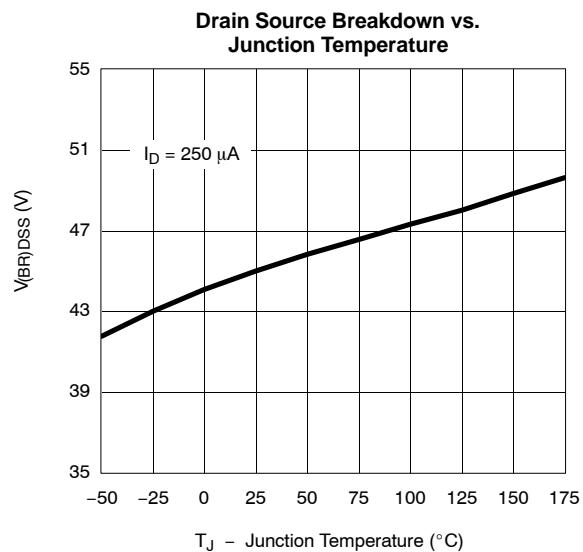
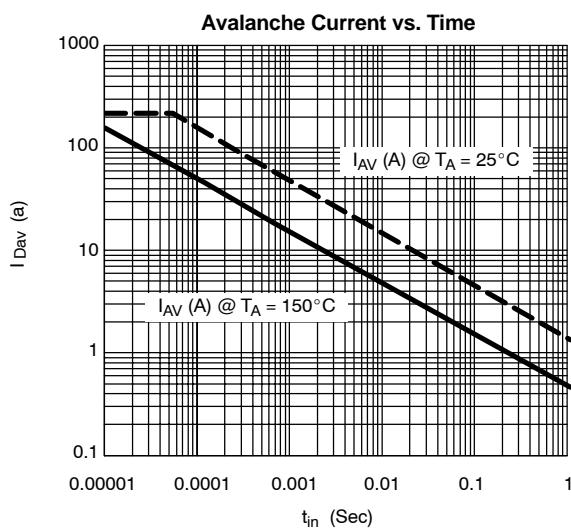
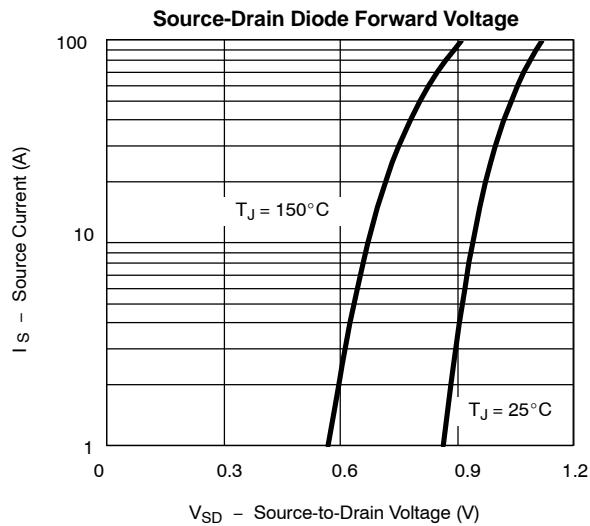
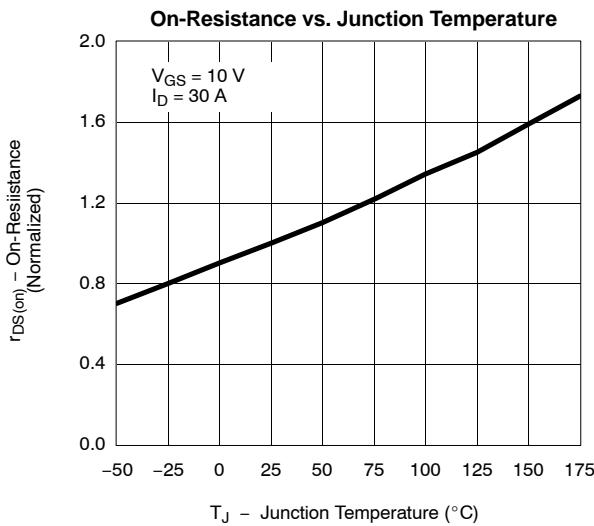
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

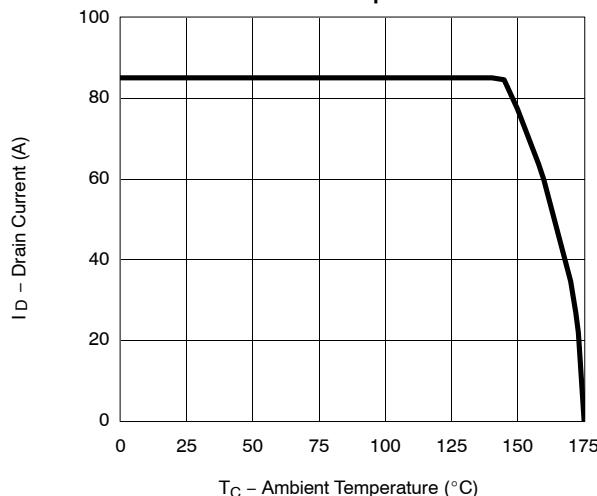
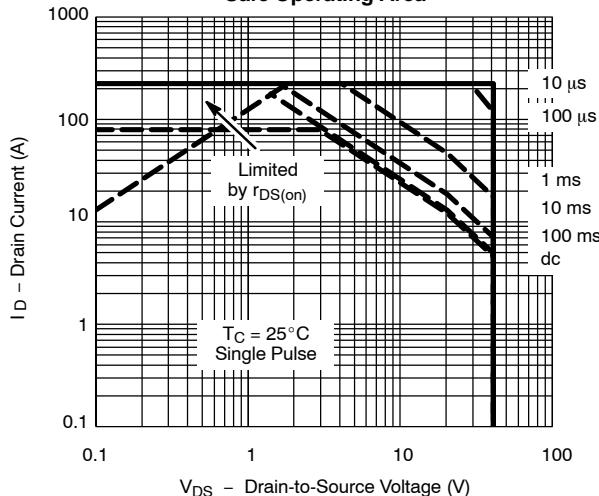
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{DS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V
Gate-Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	2		4	
Gate-Body Leakage	I_{GSS}	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = 20 \text{ V}$			100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 40 \text{ V}, V_{\text{GS}} = 0 \text{ V}$			1	μA
		$V_{\text{DS}} = 40 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 125^\circ\text{C}$			50	
		$V_{\text{DS}} = 40 \text{ V}, V_{\text{GS}} = 0 \text{ V}, T_J = 175^\circ\text{C}$			250	
On-State Drain Current ^a	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \geq 5 \text{ V}, V_{\text{GS}} = 10 \text{ V}$	120			A
Drain-Source On-State Resistance ^a	$r_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10 \text{ V}, I_D = 30 \text{ A}$		0.0031	0.004	Ω
		$V_{\text{GS}} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125^\circ\text{C}$			0.0055	
		$V_{\text{GS}} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175^\circ\text{C}$			0.007	
Forward Transconductance ^a	g_{fs}	$V_{\text{DS}} = 15 \text{ V}, I_D = 30 \text{ A}$	30			S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0 \text{ V}, V_{\text{DS}} = 25 \text{ V}, f = 1 \text{ MHz}$		7620		pF
Output Capacitance	C_{oss}			1325		
Reverse Transfer Capacitance	C_{rss}			710		
Total Gate Charge ^c	Q_g	$V_{\text{DS}} = 30 \text{ V}, V_{\text{GS}} = 10 \text{ V}, I_D = 85 \text{ A}$		160	250	nC
Gate-Source Charge ^c	Q_{gs}			40		
Gate-Drain Charge ^c	Q_{gd}			55		
Turn-On Delay Time ^c	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30 \text{ V}, R_L = 0.47 \Omega$ $I_D \approx 85 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, R_g = 2.5 \Omega$		20	35	ns
Rise Time ^c	t_r			115	175	
Turn-Off Delay Time ^c	$t_{\text{d}(\text{off})}$			75	115	
Fall Time ^c	t_f			85	130	
Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$)^b						
Continuous Current	I_S				85	A
Pulsed Current	I_{SM}				240	
Forward Voltage ^a	V_{SD}	$I_F = 85 \text{ A}, V_{\text{GS}} = 0 \text{ V}$		1.1	1.4	V
Reverse Recovery Time	t_{rr}	$I_F = 85 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		60	90	ns
Peak Reverse Recovery Current	$I_{\text{RM}(\text{REC})}$			2.6	4	A
Reverse Recovery Charge	Q_{rr}			0.08	0.15	μC

Notes

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)
Output Characteristics

Transfer Characteristics

Transconductance

On-Resistance vs. Drain Current

Capacitance

Gate Charge


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

THERMAL RATINGS
Maximum Avalanche and Drain Current vs. Case Temperature

Safe Operating Area

Normalized Thermal Transient Impedance, Junction-to-Case
